#### **PRELIMINARY**

Notice: This is not a final specification. Some parametric limits are subject to change.

## MITSUBISHI SEMICONDUCTOR <GaAs FET>

# MGFL45V1920A

Unit : millimeters (inches)

## 1.9 - 2.0GHz BAND 32W INTERNALLY MATCHED GaAs FET

OUTLINE DRAWING

2. OHIN. (0. 079H)

17.4±0.2 (0.685±0.008)

#### DESCRIPTION

The MGFL45V1920A is an internally impedance-matched GaAs power FET especially designed for use in 1.9 - 2.0 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

#### **FEATURES**

Class A operation Internally matched to 50(ohm) system High output power P1dB = 32W (TYP.) @ f=1.9 - 2.0 GHz High power gain GLP = 13 dB (TYP.) @ f=1.9 - 2.0GHz High power added efficiency P.A.E. = 45 % (TYP.) @ f=1.9 - 2.0GHz Low distortion [item -51] IM3=-45dBc(TYP.) @Po=34.5dBm S.C.L.

#### **APPLICATION**

item 01: 1.9 - 2.0 GHz band power amplifier

item 51: 1.9 - 2.0 GHz band digital ratio communication

### **QUALITY GRADE**

IG

#### RECOMMENDED BIAS CONDITIONS

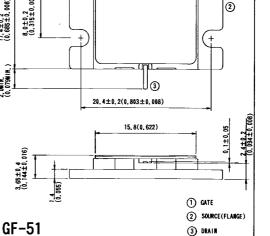
VDS = 10(V)ID = 6.5 (A)RG=25 (ohm)

## **ABSOLUTE MAXIMUM RATINGS**

(Ta=25deg.C)

| Symbol | Parameter               | Ratings    | Unit  |  |
|--------|-------------------------|------------|-------|--|
| VGDO   | Gate to drain voltage   | -15        | V     |  |
| VGSO   | Gate to source voltage  | -15        | V     |  |
| ID     | Drain current           | 22         | Α     |  |
| IGR    | Reverse gate current    | -61        | mA    |  |
| IGF    | Forward gate current    | 76         | mA    |  |
| PT *1  | Total power dissipation | 100        | W     |  |
| Tch    | Channel temperature     | 175        | deg.C |  |
| Tstg   | Storage temperature     | -65 / +175 | deg.C |  |

<sup>1 :</sup> Tc=25deg.C



24.0±0.3(0.945±0.012)

< Keep safety first in your circuit designs! > Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (1)placement of substitutive, auxiliary circuits, (2)use of non-flammable material or (3)prevention against any malfunction or mishap

#### **ELECTRICAL CARACTERISTICS**

(Ta=25deg.C)

| Symbol       | Parameter                            | Test conditions                          | Limits |      |          | Unit    |
|--------------|--------------------------------------|--|--------|------|----------|---------|
|              |                                      |  | Min.   | Тур. | Max.     | 7       |
| VGS(off)     | Saturated drain current              | VDS = 3V , ID = 60mA                     | -      | -    | -5       | V       |
| P1dB         | Output power at 1dB gain compression |  | 44     | 45   | -        | dBm     |
| GLP          | Linear power gain                    | VDS=10V, ID(RF off)=6.5A, f=1.9 - 2.0GHz | 12     | 13   | -        | dB      |
| 1D           | Drain current                        |  | -      | 7.5  | -        | Α       |
| P.A.E.       | Power added efficiency               |  | -      | 45   | -        | %       |
| IM3 *2       | 3rd order IM distortion              | 1  | -42    | -45  | <b>-</b> | dBc     |
| Rth(ch-c) *3 | Thermal resistance                   | delta Vf method                          | -      | -    | 1.5      | deg.C/W |

<sup>\*2:</sup> item -51,2 tone test,Po=34.5dBm Single Carrier Level,f=1.9,2.1,2.0GHz,dfelta f=5MHz

\*3: Channel-case

